

Correction

Correction: Gupta et al. A Correlation with the Deformation Stored Energy and Self-Annealing Behavior of ETP-Cu. *Metals* 2026, 16, 432

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In the original publication [1], Shi-Hoon Choi was not included as a corresponding author. The corrected Author Contributions statement appears here.

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The authors state that the scientific conclusions are unaffected. This correction was approved by the Academic Editor. The original publication has also been updated.

Reference

1. Gupta, A.; Tiwari, S.; Choi, S.-H. A Correlation with the Deformation Stored Energy and Self-Annealing Behavior of ETP-Cu. *Metals* **2026**, *16*, 432. [[CrossRef](#)]

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